



## **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> Ta = +25°C
-40V	$11m\Omega @ V_{GS} = -10V$	-10.8A
	15mΩ @ V <sub>GS</sub> = -4.5V	-9.6A

This MOSFET is designed to meet the stringent requirements of

automotive applications. It is qualified to AEC-Q101, supported by a

#### 40V P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Features and Benefits**

- 100% Unclamped Inductive Switch (UIS) Test in Production Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP4016SSSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



**Description and Applications** 

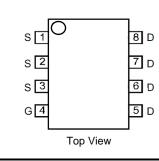
PPAP, and is ideal for use in:

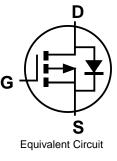
**DC-DC** converters

Analog switches

Power-management functions

Top View





## Ordering Information (Note 4)

Part Number	Backaga	Packing		
Fart Number	Package	Qty.	Carrier	
DMP4016SSSQ-13	SO-8	2,500	Tape & Reel	

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

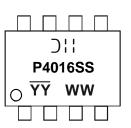
Lead-free.

Notes:

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**





## Maximum Ratings (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage	Vdss	-40	V		
Gate-Source Voltage		V <sub>GSS</sub>	±20	V	
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-10.8 -8.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	-112	A
Maximum Body Diode Continuous Current (Note 6)			ls	-10.8	A
Avalanche Current, L = 1mH			las	-26	A
Avalanche Energy, L = 1mH			Eas	338	mJ

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	80.2	°C/W
Total Power Dissipation (Note 6)	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	60.4	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	7.8	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-40			V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μA	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	-1.5	—	-2.5	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Descent		6	11	mΩ	$V_{GS} = -10V, I_D = -9.8A$	
	RDS(ON)	_	8.5	15	11152	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -9.8A	
Diode Forward Voltage	Vsd	_	-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	5697			$V_{DS} = -20V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss		534		pF		
Reverse Transfer Capacitance	Crss	_	408				
Gate Resistance	Rg	_	7		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	53	_			
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	112	_	nC	V <sub>DS</sub> = -20V, I <sub>D</sub> = -9.8A	
Gate-Source Charge	Qgs		20		nc		
Gate-Drain Charge	Qgd	_	18	_			
Turn-On Delay Time	t <sub>D(ON)</sub>		11.5			$V_{GS} = -10V, V_{DD} = -20V,$ $R_G = 2\Omega, I_D = -9.8A$	
Turn-On Rise Time	tR		41				
Turn-Off Delay Time	tD(OFF)	_	146	_	ns		
Turn-Off Fall Time	tF	_	165	_			
Reverse Recovery Time	t <sub>RR</sub>	_	27	_	ns	IF = -9.8A, di/dt = -100A/µs	
Reverse Recovery Charge	Q <sub>RR</sub>	_	22	_	nC	I <sub>F</sub> = -9.8A, di/dt = -100A/µs	

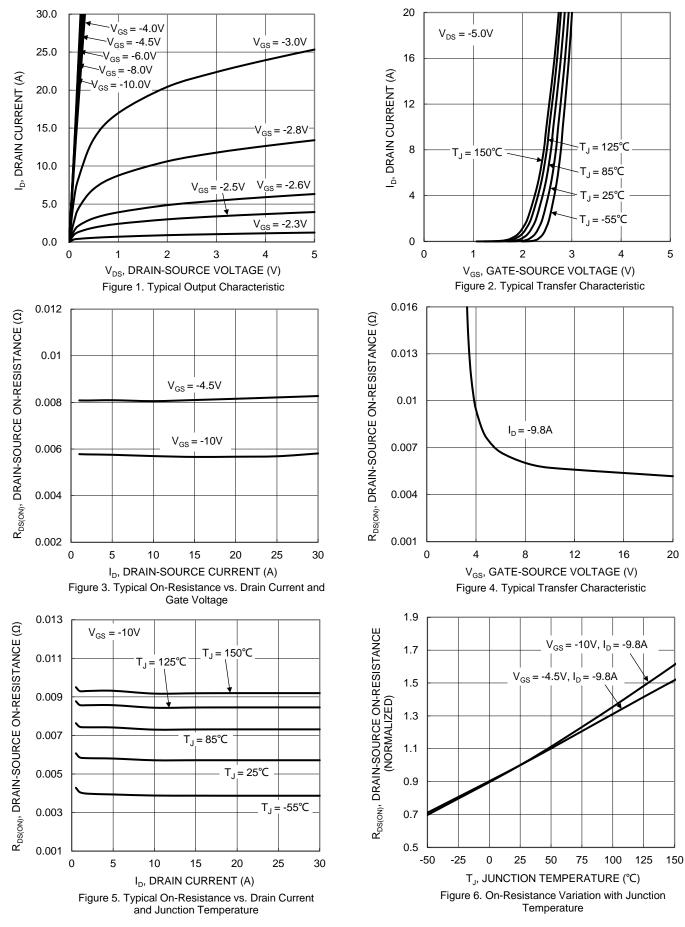
Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

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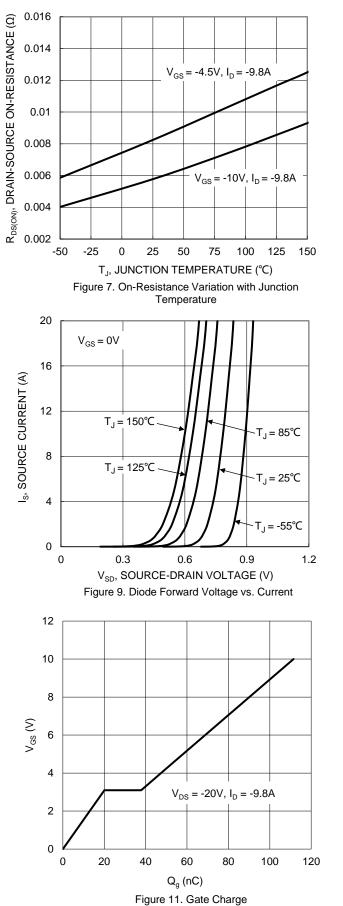
#### DMP4016SSSQ

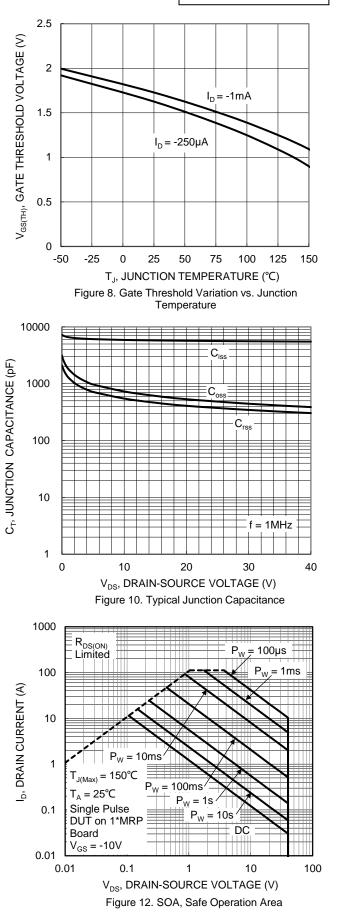


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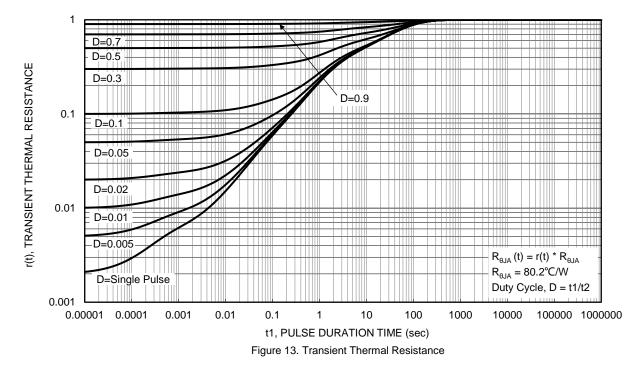
## DMP4016SSSQ





DMP4016SSSQ Document number: DS45469 Rev. 2 - 2

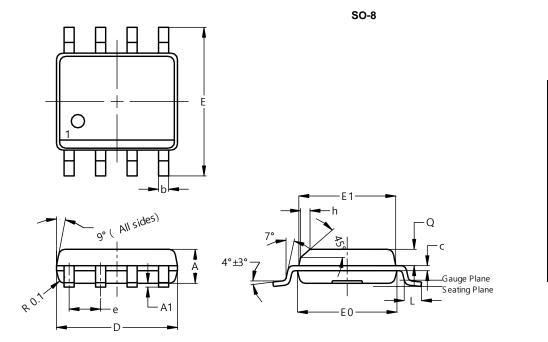






## **Package Outline Dimensions**

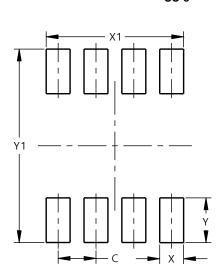
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
ш	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е	-		1.27			
h			0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50

SO-8



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